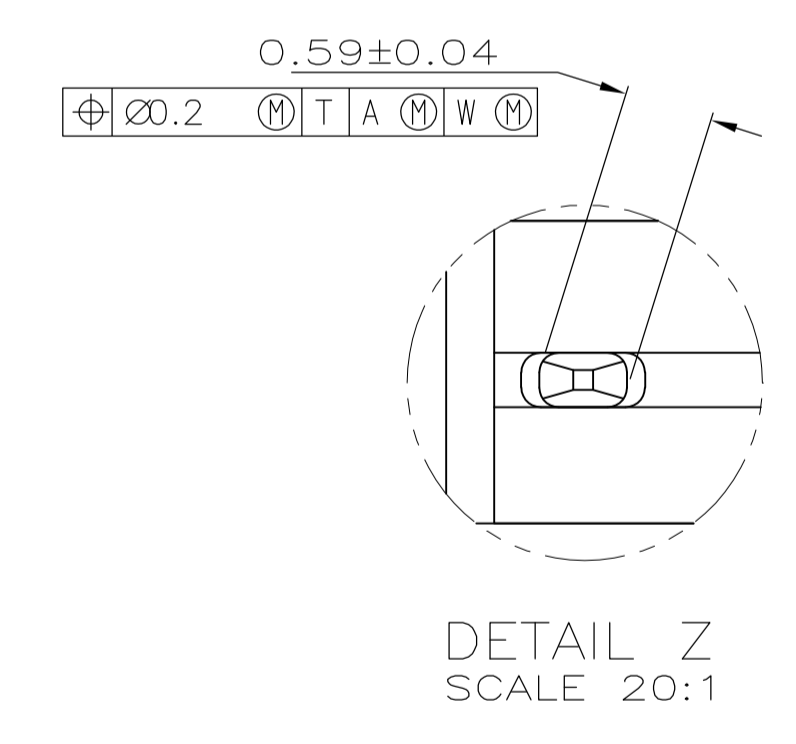
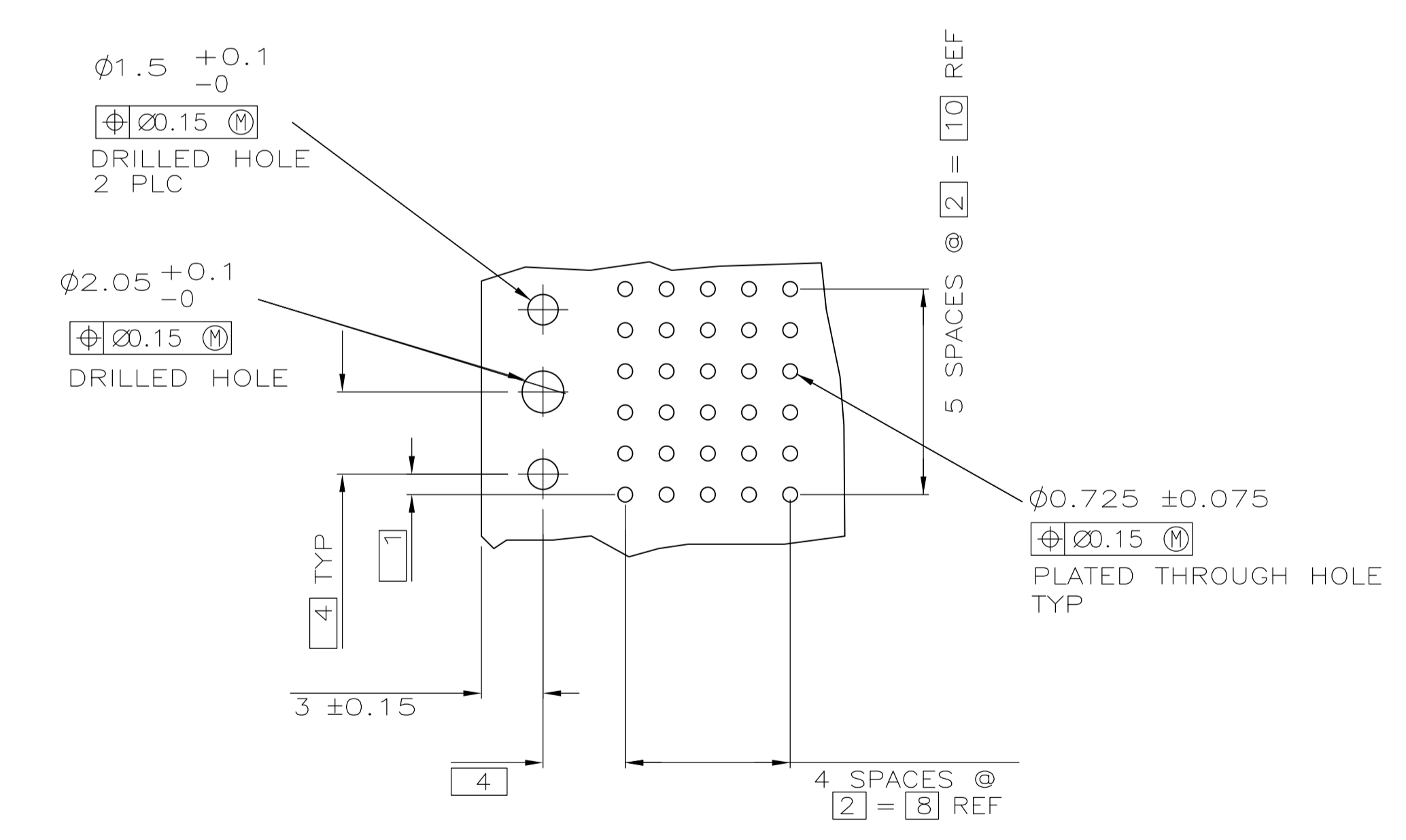
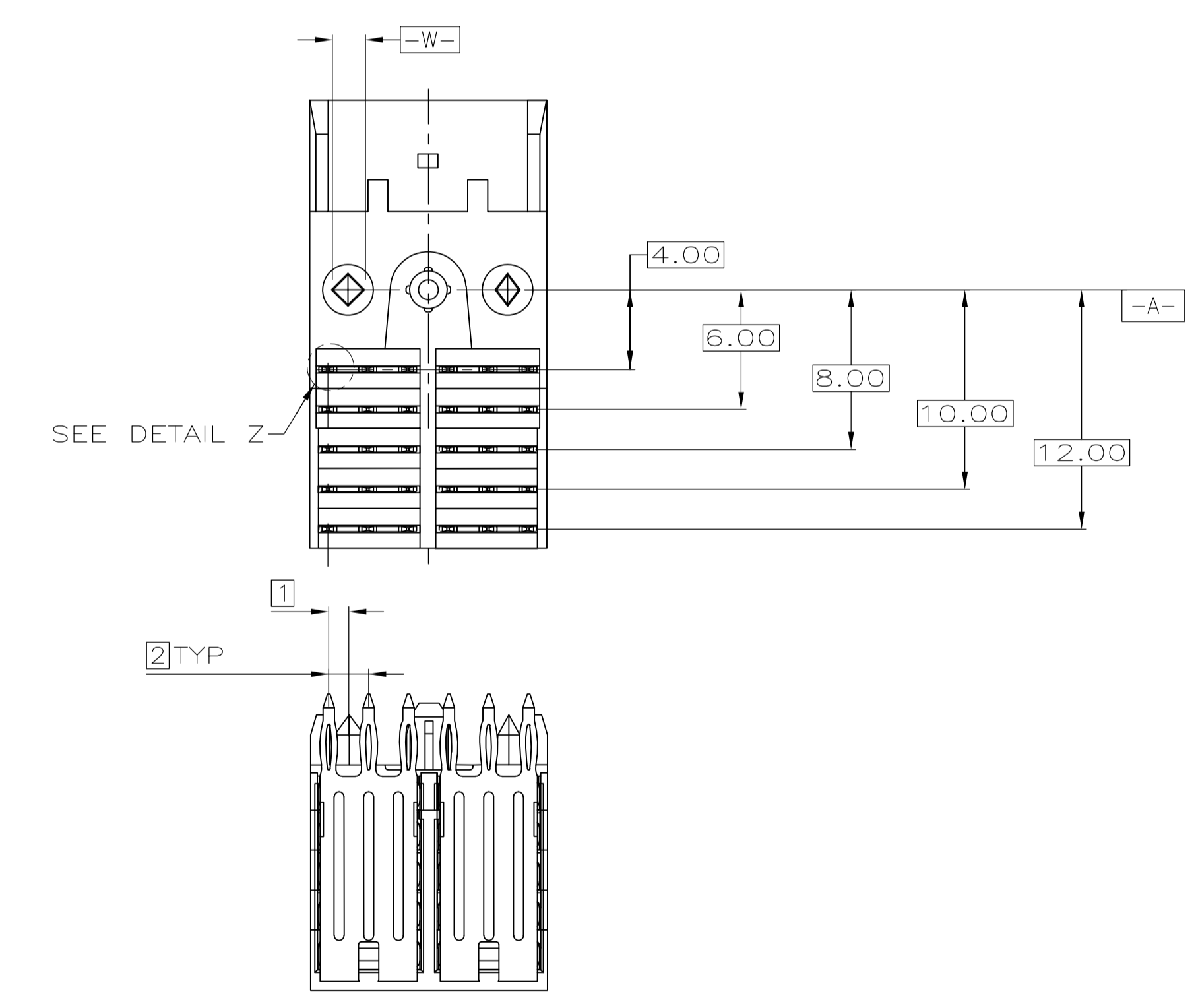
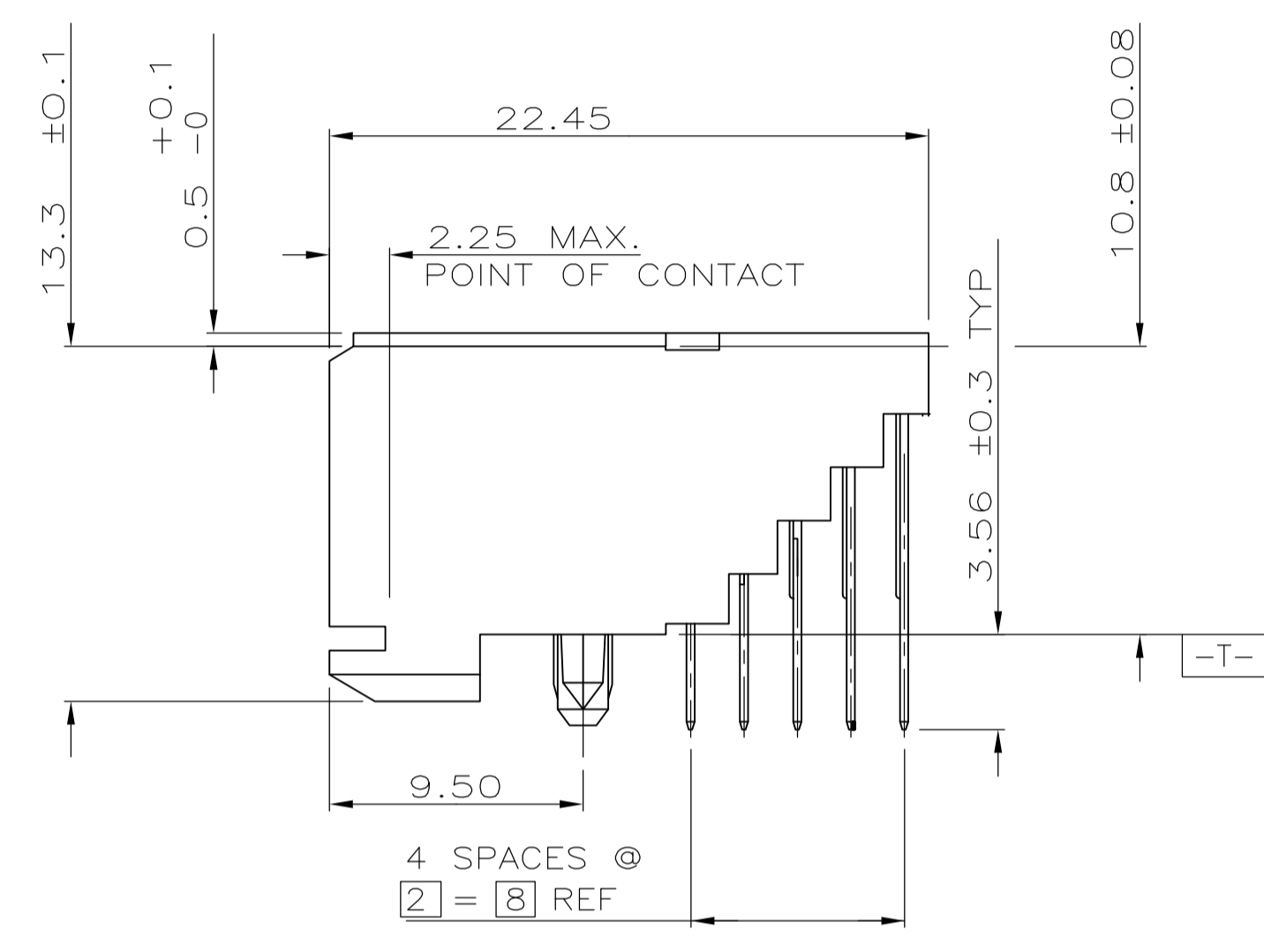
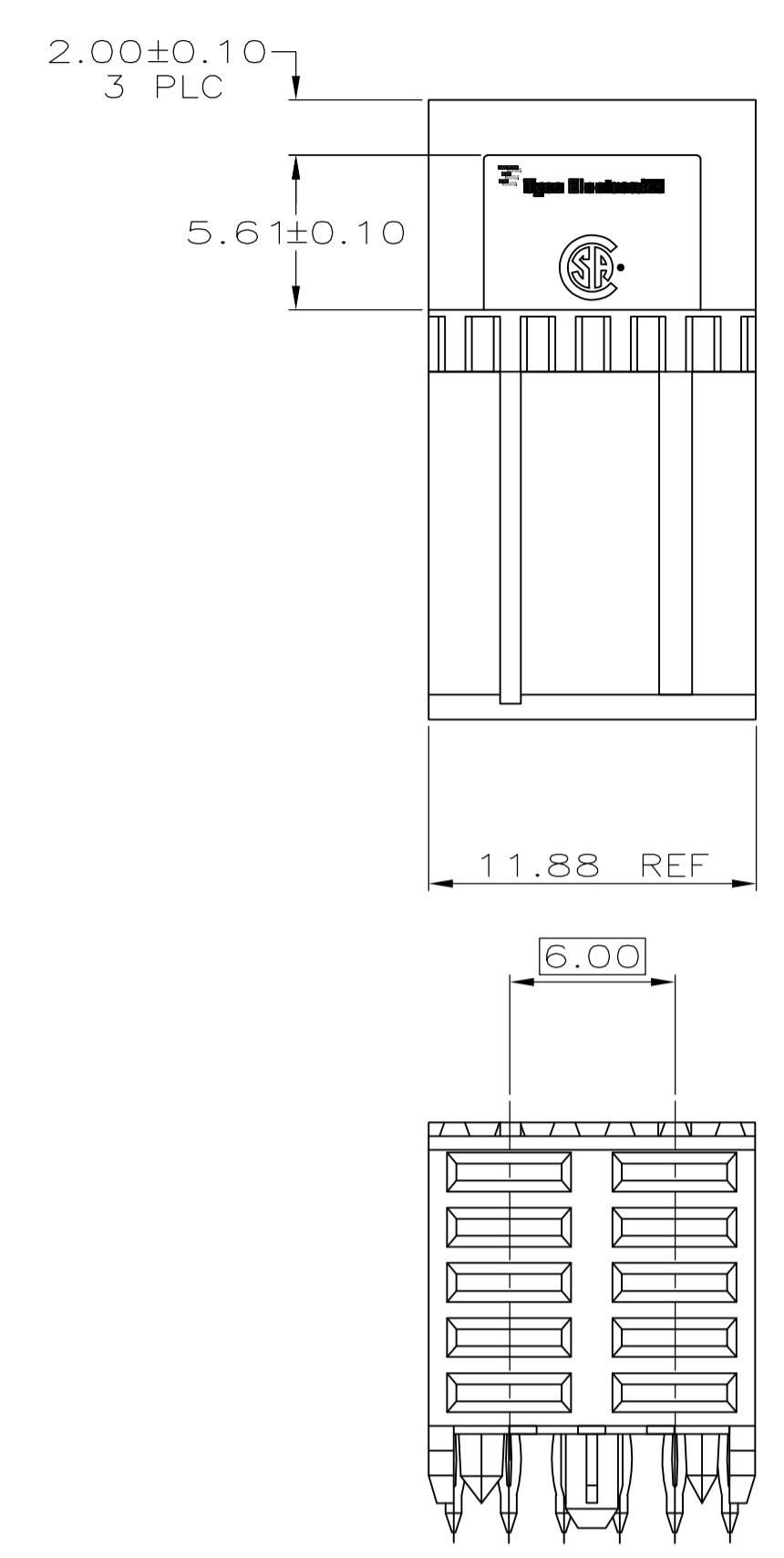


LOC		DIST		REVISIONS			
P	LTR	DESCRIPTION	DATE	DWN	APVD		
01		REVISED PER ECO-08-009182	22APR08	DH	AS		



RECOMMENDED CIRCUIT PATTERN  
 PER IPC-D300 TYPE II, CLASS C  
 (COMPONENT SIDE)

- 1 HOUSINGS MATERIAL: LIQUID CRYSTAL POLYMER.
- 2 CONTACT MATERIAL: COPPER ALLOY
- 3 CONTACT FINISH:(D)  
 UNDERPLATE (ENTIRE CONTACT):  
 0.00127 MIN NICKEL PER SAE-AMS-QQ-N-290  
 ON MATING SURFACES:  
 FLASH GOLD PER ASTM B 488, OVER  
 0.00076 MIN PALLADIUM-NICKEL OVER UNDERPLATE, OR  
 0.00076 MIN GOLD PER ASTM B 488 OVER UNDERPLATE.  
 ON LEADS:  
 0.00127 MIN MATTE TIN PER ASTM B 545 OVER UNDERPLATE.  
 LUBRICATION (MIN MATING SURFACES):  
 SURFACE CONDITIONER AFTER PLATING.

3	10	5536649-1
FINISH	NO OF POSN	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DIN T. SHUEY 2-18-98	Tyco Electronics Corporation Harrisburg, Pa 17105-3608	
DIMENSIONS: mm		CHK W. MILLHIMES 3-5-98	NAME ASSEMBLY, RECEPTACLE, 5 ROW, POWER MODULE, PRESS FIT LEAD, 3.56mm LEAD LENGTH, Z-PACK 2mm FB	
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD W. MILLHIMES 3-5-98	APPLICATION SPEC	
0 PLC ± -		SIZE A1		
1 PLC ± -		CAGE CODE 00779		
2 PLC ± 0.13 [0.005]		DRAWING NO 5536649		
3 PLC ± 0.013		RESTRICTED TO		
4 PLC ± - # 2'		SCALE 4:1		
MATERIAL		SHEET 1 OF 1		
FINISH		REV 01		
CUSTOMER DRAWING				

单击下面可查看定价，库存，交付和生命周期等信息

[>>TE Connectivity\(泰科\)](#)